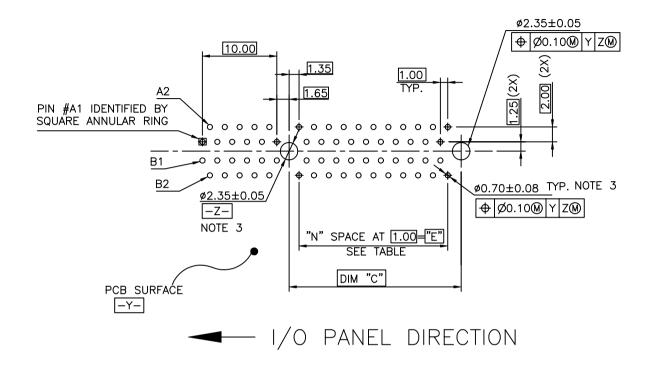


ACAD

3 1 | 2



RECOMMENDED FOOTPRINT

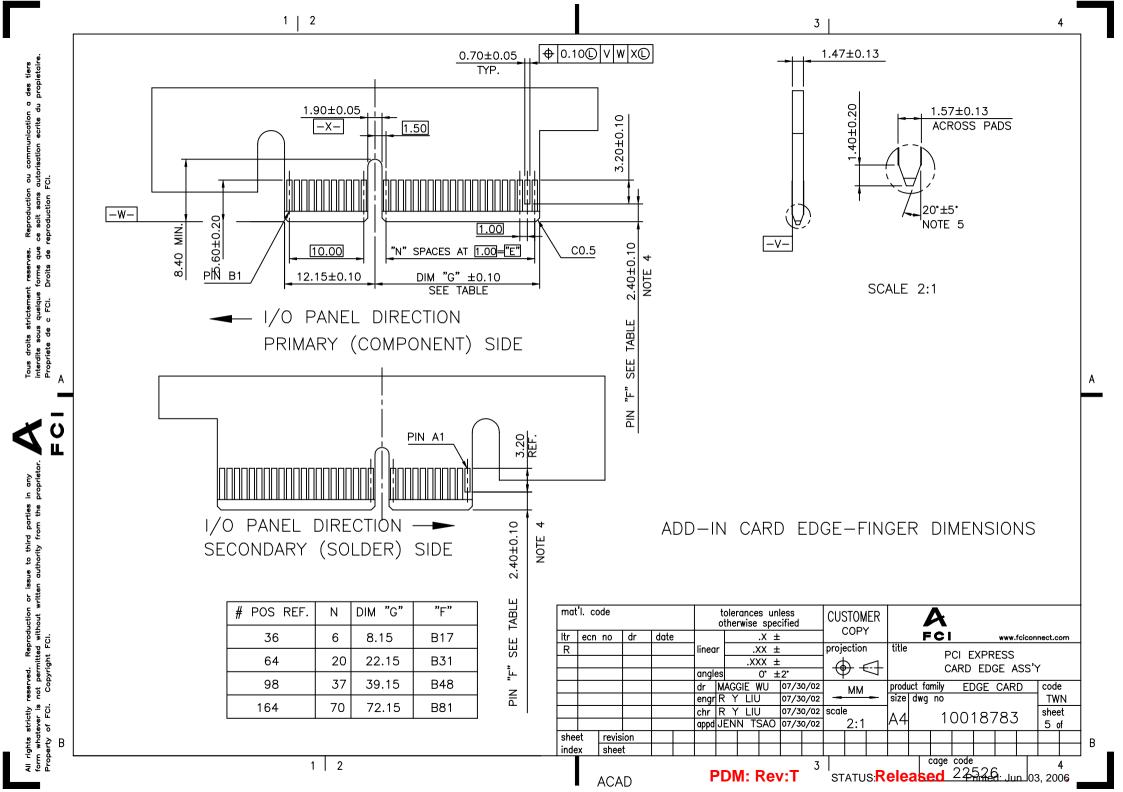
1 2

mat'l. code						tolerances unless otherwise specified						CUSTOMER			A								
ltr	ecn	n no dr date			.X ±				:	COPT				F	CI			www.	fcico	nnect.c	om		
R						linea	r 🗀	.XX ±				proje	ection	1	title	title				FCC			
							.XXX ± 0° ±2°				♦ ◁			PCI EXPRESS CARD EDGE ASS'Y									
					angle	es																	
						dr	MAG			07/30/02 07/30/02		ММ		product family EDGE CARD co					cod	е			
						engr	RY					- 			size	dwg	no	o TW					/N
						chr	RY	R Y LIU		07/30/02		scale		امرا	10018783 sheet							et	
						appd	JEN	ENN TSAO		07/30/02		2:1		Α4		10010703				J	4 of		
she	et	revision																					
inde	x	shee	sheet																				
						_	ם בי	л.	Day	T	3	Τ		- D	مام			code	526	 ` .		0.00	4

■ ACAD

PDM: Rev: I

STATUS: Released 4 Printed: Jun 103, 2006



3 NOTES: 1.MATERIAL: HOUSING: HIGH TEMPERATURE NYLON, GLASS FILLED UL94V-0 RATED. SUITABLE FOR REFLOW SOLDERING. DIM "A" DIM "B' DIM "C" "F" CONNECTOR # POS REF. TERMINAL: COPPER ALLOY Ν PLATING: 50u" NICKEL UNDERPLATE ALL OVER 1 PORT CONTACT AREA PLATING - SEE PRODUCT NUMBER CODE 36 6 7.65 25.00 9.15 6.00 SOLDER TAIL: TIN OR TIN /LEAD(90/10)- SEE PRODUCT NUMBER CODE 100u" MIN. OVER 50u" NICKEL 4 PORT 64 20 21.65 39.00 23.15 20.00 METAL BOARD LOCKS: COPPER ALLOY FINISH: 100u" TIN OR TIN/LEAD(90/10) OVER 50u" NICKEL 37 8 PORT 98 38.65 56.00 40.15 37.00 UNDERPLATE SEE PRODUCT NUMBER CODE 2.PRODUCT SPECIFICATION: GS-12-233 16 PORT 164 70 71.65 89.00 73.15 70.00 (3)THE HORIZONTAL AXIS FOR THE HOLE PATTERN IS ESTABLISHED BY A LINE THROUGH THE CENTER OF THE TWO #2.35 HOLES. THE VERTICAL AXIS IS 90° TO THE HORIZONTAL AXIS, THROUGH THE CENTER 4)NO TIE BAR PERMITTED FROM CARD EDGE TO LEADING EDGE OF PAD FOR PINS A1 AND PIN NUMBERS "F". (5) CHAMFER EDGES MUST BE FREE OF CUTTING BURRS. (6) FREQUENCY & LOCATION AT SUPPLIER DISCRETION, RIDGE MAY BE CONTINUOUS WITH NO BREAKS. 7.RoHS COMPATIBLE PRODUCT SPECIFICATIONS a - PLATING: - "LF" MEANS THE PRODUCT IS LEAD-FREE, 2um MINIMUM MATTE TIN OVER 1.27um MINIMUM NICKEL UNDERPLATE. b - MANUFACTURING PROCESS COMPATIBILITY - THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A REFLOW SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD. PRODUCT NUMBER CODE 10018783 -<u>x x x x x x x u u u</u> HOUSING COLOR OPTIONS LEAD FREE OPTION LEAVE BLANK FOR TERMINAL PLATING 3.4.5 0-NATURAL "LF" FOR TERMINAL PLATING OPTION 0.1.2 1-BLACK PACKAGING OPTIONS PEGS OPTIONS T-TRAY PACKAGING M-TRAY PACKAGING & MYLAR TAPE FOR PICK-N-PLACE, SEE PIGULE 1 0-PLASTIC PEGS 1-METAL BOARD LOCKS POS OPTIONS 2-SINGLE PLASTIC PEGS TAIL LENGTH OPTIONS 0-36 1-64 TERMINAL PLATING OPTIONS 2-98 DIM "D" PCB THICKNESS BOARD LOCKS DIM "G" 0-50u" Ni UNDERPLATE 3-164 30u" Au CONTACT AREA 0 2.30 +0.25 1.56±0.10 1.70 ± 0.15 100u" TIN TAIL AREA ---- COMPATIBLE RoHS 1-50u" Ni UNDERPLATE 15u" Au CONTACT AREA $3.10^{+0.25}_{-0.13}$ 2.36±0.10 2.50 ± 0.15 100u" TIN TAIL AREA ---- COMPATIBLE RoHS 1.56±0.10 2.54±0.25 1.70±0.15 2-50u" Ni UNDERPLATE GOLD FLASH CONTACT AREA 100u" TIN TAIL AREA ---- COMPATIBLE RoHS 3-50u" Ni UNDERPLATE 30u" Au CONTACT AREA mat'l. code tolerances unless CUSTOMER 100u" TIN/LEAD TAIL AREA ---- INCOMPLIANT RoHS otherwise specified 4-50u" Ni UNDERPLATE COPY Itr ecn no dr date .X ± FCI www.fciconnect.com 15u" Au CONTACT AREA projection title linear .XX ± 100u" TIN/LEAD TAIL AREA ---- INCOMPLIANT ROHS PCI EXPRESS .XXX ± 5-50u" Ni UNDERPLATE CARD EDGE ASS'Y GOLD FLASH CONTACT AREA angles 0° ±2° 100u" TIN/LEAD TAIL AREA ---- INCOMPLIANT RoHS dr MAGGIE WU 07/30/02 product family EDGE CARD code MM engr R Y LIU 07/30/02 size dwg no TWN chr R Y LIU 07/30/02 scale sheet 10018783 appd JENN TSAO 07/30/02 1:1 6 of sheet revision

ACAD

sheet

index

1 2

3 STATUS: Released 225,26 Jun 03, 2006 PDM: Rev:T

cage code

